

## 捷多邦,专业PCB打样工厂,24小时加急出货

# KA1M0765R/KA1M0765RC Fairchild Power Switch(FPS)

### Features

- Precision fixed operating frequency (67kHz)
- Pulse by pulse current limiting
- Over load protection
- Over voltage protecton (Min. 23V)
- Internal thermal shutdown function
- Under voltage lockout
- Internal high voltage sense FET

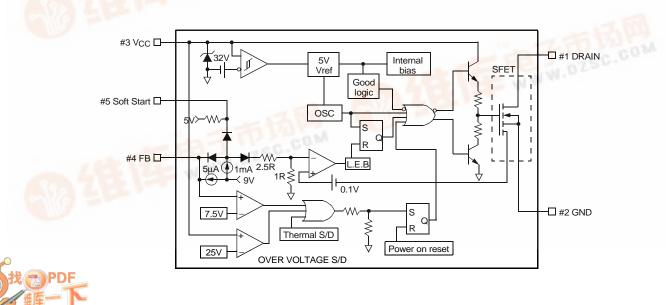
Internal Block Diagram

- Auto restart
- Soft start

### Description

The Fairchild Power Switch(FPS) product family is specially designed for an off line SMPS with minimal external components. The Fairchild Power Switch(FPS) consist of high voltage power SenseFET and current mode PWM controller IC. PWM controller features integrated fixed frequency oscillator, under voltage lock out, leading edge blanking, optimized gate turn-on/turn-off driver, thermal shutdown protection, over voltage protection, temperature compensated precision current sources for loop compensation and fault protection circuit. compared to discrete MOSFET and PWM controller or R<sub>CC</sub> solution, a Fairchild Power Switch(FPS) can reduce total component count, design size, weight and at the same time increase efficiency, productivity, and system reliability. It has a basic platform well suited for cost effective design in either a flyback converter or a forward converter.





## **Absolute Maximum Ratings**

Characteristic	Symbol	Value	Unit	
Maximum Drain voltage <sup>(1)</sup>	VD,MAX	650	V	
Drain-Gate voltage (R <sub>GS</sub> =1MΩ)	Vdgr	650	V	
Gate-source (GND) voltage	VGS	±30	V	
Drain current pulsed <sup>(2)</sup>	IDM	28.0	ADC	
Single pulsed avalanche energy <sup>(3)</sup>	EAS	570	mJ	
Continuous drain current (Tc=25°C)	ID	7.0	ADC	
Continuous drain current (T <sub>C</sub> =100°C)	ID	5.6	ADC	
Maximum Supply voltage	VCC,MAX	30	V	
Input voltage range	VFB	–0.3 to V <sub>SD</sub>	V	
	PD	140	W	
Total power dissipation	Derating	1.11	W/°C	
Operating ambient temperature	TA	-25 to +85	°C	
Storage temperature	TSTG	-55 to +150	°C	

#### Notes:

- 1. Tj=25°C to 150°C
- 2. Repetitive rating: Pulse width limited by maximum junction temperature
- 3. L=24mH, VDD=50V, RG=25 $\Omega$ , starting Tj=25°C

## **Electrical Characteristics (SFET part)**

(Ta =  $25^{\circ}$ C unless otherwise specified)

Characteristic	Symbol	Test condition	Min.	Тур.	Max.	Unit
Drain-source breakdown voltage	BVDSS	VGS=0V, ID=50µA	650	-	-	V
Zero gate voltage drain current	IDSS	V <sub>DS</sub> =Max., Rating, V <sub>GS</sub> =0V	-	-	50	μA
		V <sub>DS</sub> =0.8Max., Rating, V <sub>GS</sub> =0V, T <sub>C</sub> =125°C	-	-	200	mA
Static drain-source on resistance (note)	RDS(ON)	VGS=10V, ID=4.0A	-	1.25	1.6	W
Forward transconductance (note)	gfs	VDS=15V, ID=4.0A	3.0	-	-	S
Input capacitance	Ciss	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1MHz	-	1600	-	pF
Output capacitance	Coss		-	310	-	
Reverse transfer capacitance	Crss		-	120	-	
Turn on delay time	td(on)	VDD=0.5BVDSS, ID=7.0A (MOSFET switching time are essentially independent of operating temperature)	-	25	-	
Rise time	tr		-	55	-	
Turn off delay time	td(off)		-	80	-	nS
Fall time	tf		-	50	-	
Total gate charge (gate-source+gate-drain)	Qg	VGS=10V, ID=7.0A, VDS=0.5BVDSS (MOSFET switching time are essentially independent of operating temperature)	-	-	72	
Gate source charge	Qgs		-	9.3	-	nC
Gate drain (Miller) charge	Qgd		-	29.3	-	

#### Note:

Pulse test: Pulse width  $\leq$  300µS, duty  $\leq$  2%

$$S = \frac{1}{R}$$

## **Electrical Charcteristics (CONTROL part)**

(Ta = 25°C unless otherwise specified)

Characteristic	Symbol	Test condition	Min.	Тур.	Max.	Unit
UVLO SECTION						1
Start threshold voltage	VSTART	-	14	15	16	V
Stop threshold voltage	VSTOP	After turn on	9	10	11	V
OSCILLATOR SECTION						
Initial accuracy	Fosc	Ta=25°C	61	67	73	kHz
Frequency change with temperature <sup>(2)</sup>	$\Delta F / \Delta T$	–25°C ≤ Ta ≤ +85°C	-	±5	±10	%
Maximum duty cycle	Dmax	-	74	77	80	%
FEEDBACK SECTION						
Feedback source current	IFB	Ta=25°C, 0V ≤Vfb ≤ 3V	0.7	0.9	1.1	mA
Shutdown Feedback voltage	VSD	-	6.9	7.5	8.1	V
Shutdown delay current	Idelay	Ta=25°C, $5V \le Vfb \le VsD$	4.0	5.0	6.0	μΑ
SOFT START SECTION						
Soft Start Voltage	Vss	VFB =2V	4.7	5.0	5.3	V
Soft Start Current	ISS	Sync & S/S=GND	0.8	1.0	1.2	mA
REFERENCE SECTION						
Output voltage <sup>(1)</sup>	Vref	Ta = 25°C	4.80	5.00	5.20	V
Temperature Stability <sup>(1)(2)</sup>	Vref/∆T	–25°C ≤ Ta ≤ +85°C	-	0.3	0.6	mV/°C
CURRENT LIMIT (SELF-PROTECTION	) SECTION					
Peak Current Limit	IOVER	Max. inductor current	4.40	5.00	5.60	A
PROTECTION SECTION						
Thermal shutdown temperature (Tj) <sup>(1)</sup>	TSD	-	140	160	-	٥C
Over voltage protection voltage	Vovp	-	23	25	28	V
TOTAL DEVICE SECTION						•
Start Up current	ISTART	VCC=14V	0.1	0.3	0.4	mA
Operating supply current (control part only)	IOP	Ta=25°C	6	12	18	mA
VCC zener voltage	Vz	ICC=20mA	30	32.5	35	V
		•				

Note:

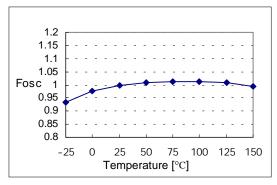
1. These parameters, although guaranteed, are not 100% tested in production

2. These parameters, although guaranteed, are tested in EDS(water test) process

3. The amplitude of the sync. pulse is recommended to be between 2V and 3V for stable sync. function.

### **Typical Performance Characteristics**

(These characteristic graphs are normalized at Ta =  $25^{\circ}$ C)



**Figure 1. Operating Frequency** 

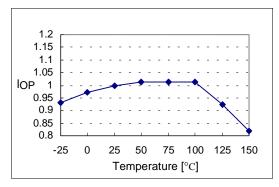


Figure 3. Operating Supply Current

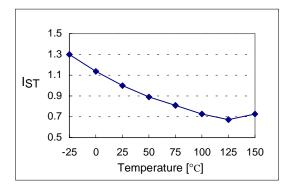


Figure 5. Start up Current

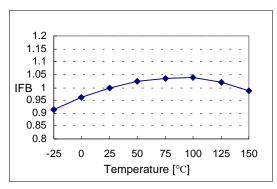


Figure 2. Feedback Source Current

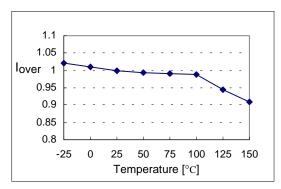


Figure 4. Peak Current Limit

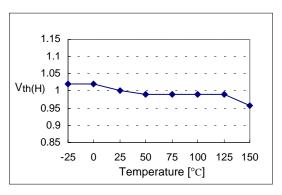


Figure 6. Start Threshold Voltage

### Typical Performance Characteristics (Continued)

(These characteristic graphs are normalized at Ta = 25°C)

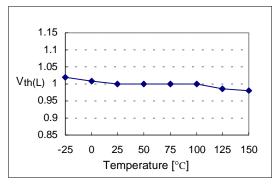


Figure 7. Stop Threshold Voltage

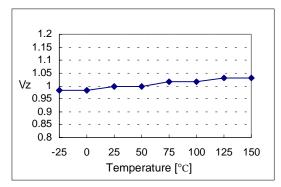


Figure 9. VCC Zener Voltage

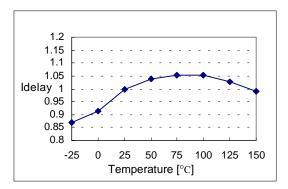


Figure 11. Shutdown Delay Current

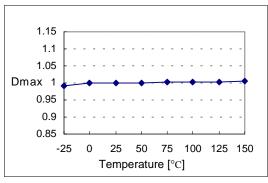


Figure 8. Maximum Duty Cycle

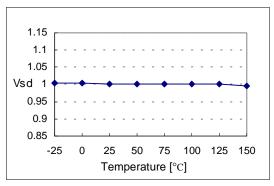


Figure 10. Shutdown Feedback Voltage

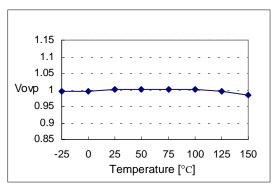


Figure 12. Over Voltage Protection

## Typical Performance Characteristics (Continued)

(These characteristic graphs are normalized at Ta =  $25^{\circ}$ C)

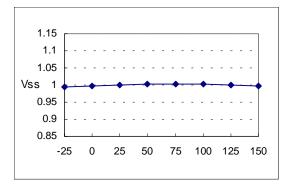


Figure13. Soft Start Voltage

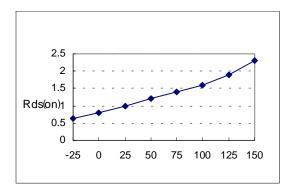
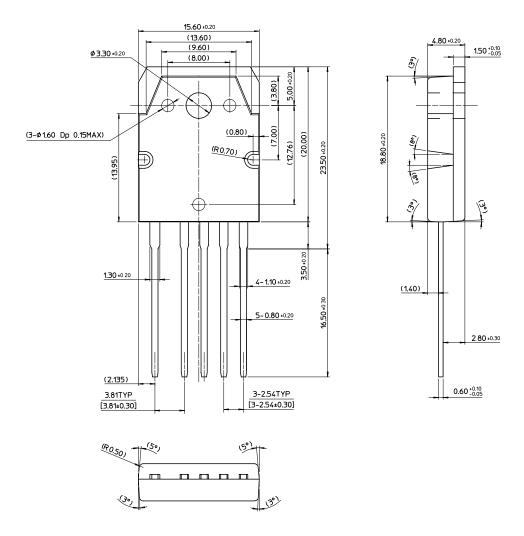


Figure 14. Static Drain-Source on Resistance

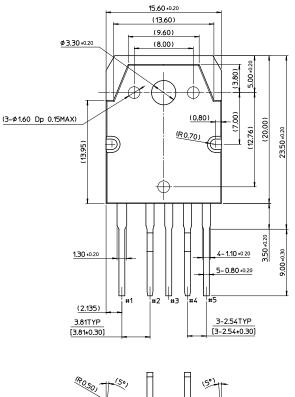
## **Package Dimensions**



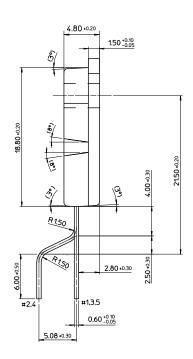


Package Dimensions (Continued)

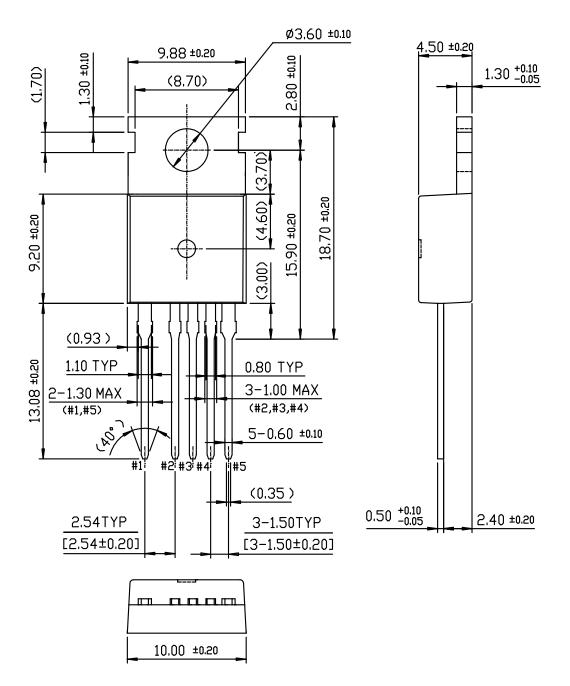
# TO-3P-5L (Forming)







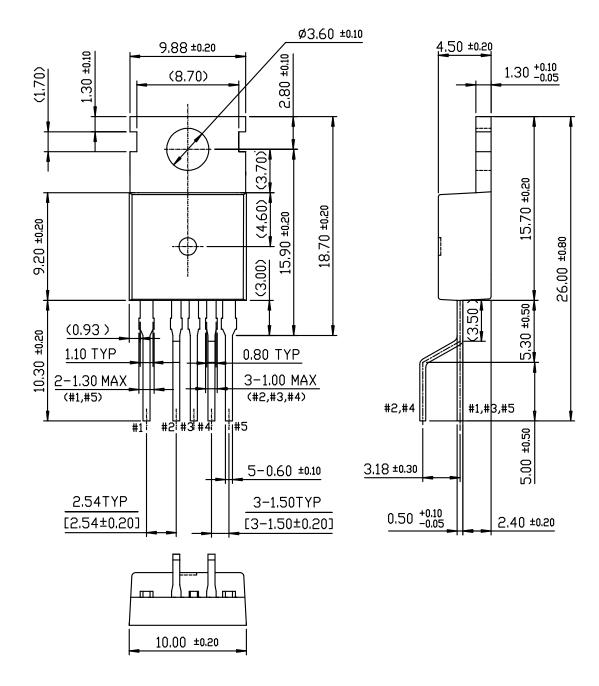
### Package Dimensions (Continued)



TO-220-5L

### Package Dimensions (Continued)

## TO-220-5L(Forming)



#### **Ordering Information**

Product Number	Package	Rating	Fosc		
KA1M0765R-TU	TO-3P-5L	650V, 7A	67kHz		
KA1M0765R-YDTU	TO-3P-5L(Forming)	0300, 7A			
KA1M0765RC-TU	TO-220-5L	650V, 7A	67kHz		
KA1M0765RC-YDTU	TO-220-5L(Forming)	000V, 7A			

TU : Non Forming Type YDTU : Forming Type

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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.